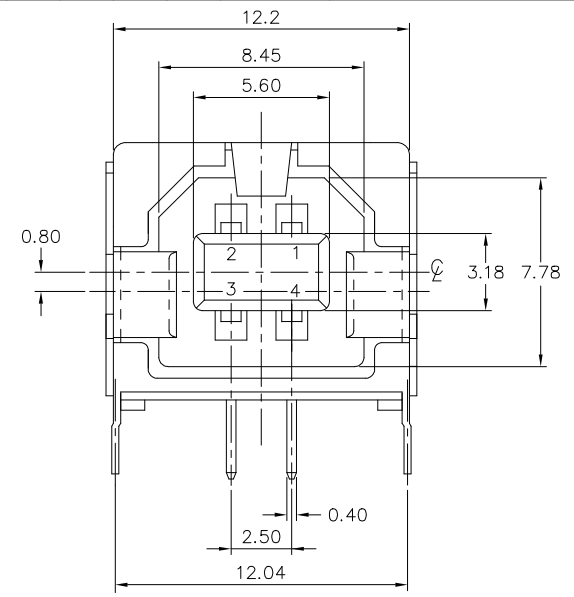
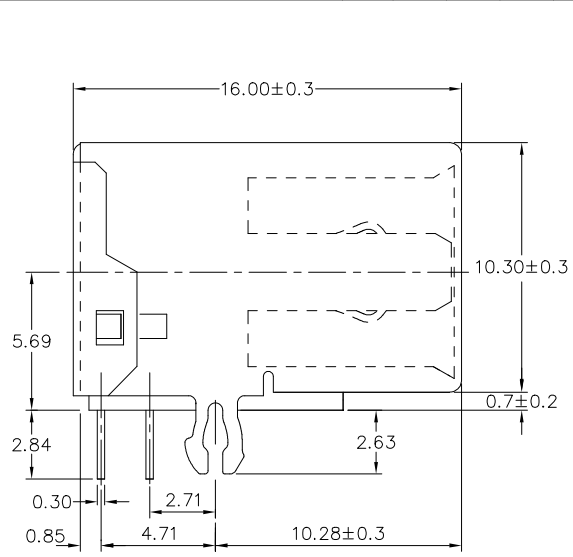
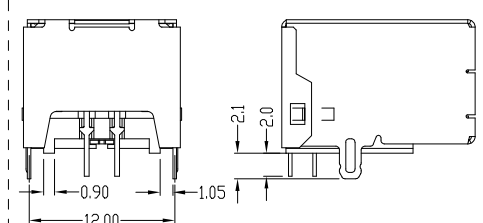
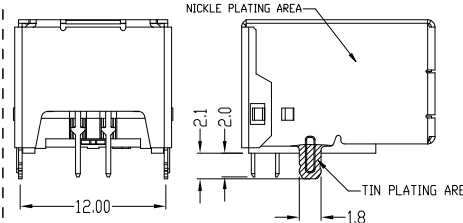
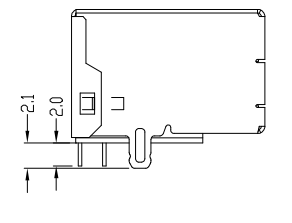
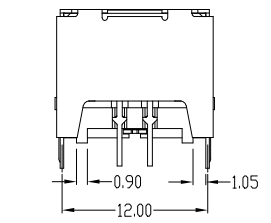


PRODUCT NO.
61729-*



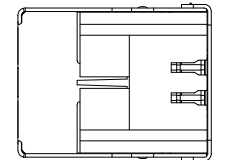
Amphenol FCI



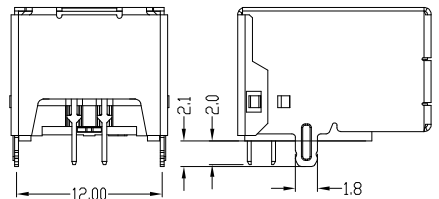
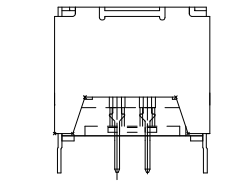
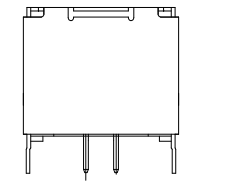
TYPE "4" PARTIAL BACK WITH SHORT SOLDER TAIL, SHELL TAIL AND SPECIAL HOUSING FOR PIP PROCESS 61729-XXWXLF

TYPE "5" PARTIAL BACK WITH SHORT SOLDER TAIL, SHORT SHELL TAIL AND SELECTED MATTE TIN SHELL FOR PIP PROCESS 61729-XXTXLF

TYPE "6" PARTIAL BACK WITH SHORT SOLDER TAIL, SHORT SHELL TAIL, SPECIAL HOUSING, AND FULL MATTE TIN SHELL FOR PIP PROCESS 61729-XXVXLF



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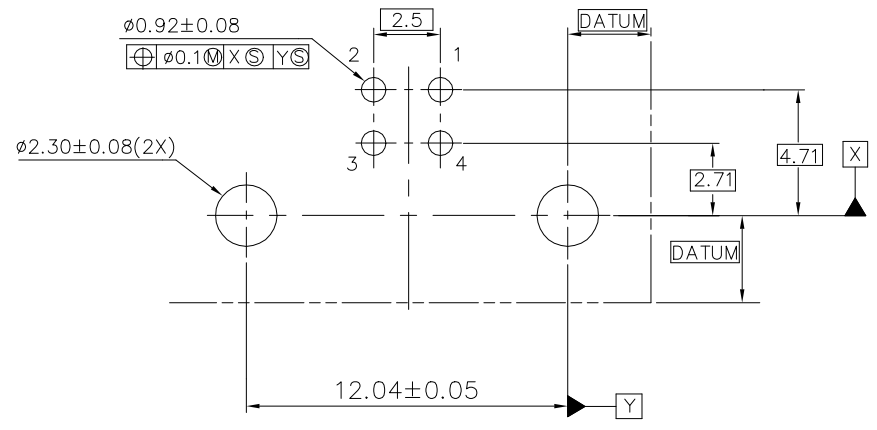
TYPE "1" FULL BACK

TYPE "2" PARTIAL BACK

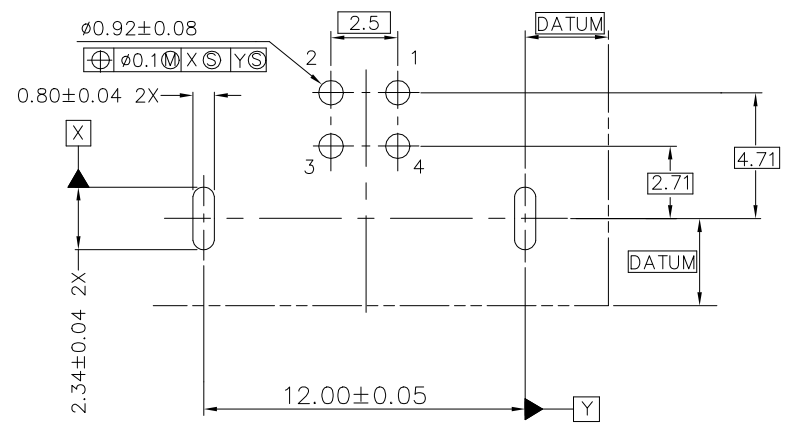
TYPE "3" PARTIAL BACK WITH SHORT SOLDER TAIL AND SHELL TAIL FOR PIP PROCESS 61729-XXQXLF

mat'l. code		surface ISO 1302 ✓		tolerance ISO 406 ISO 1101		projection		product family	
ltr ecn no dr date		tolerances unless otherwise specified		angles linear		mm		HPL 511 USB2.0	
AA	ELX-N-34768-1	YY	09/19/19	0.0±0.30				title	
AB	ELX-N-37746-1	YY	03/09/21	0.00±0.20				USB RECEPTACLE B TYPE	
AC	ELX-N-40307-1	YY	03/09/21	0.000±0.10		scale 1:1		dwg no	
W	EGR-N-16533	LQ	12/17/13	eng	Yuan-Yuan Bao	03/09/21	sheet 1 of 3		size
X	ELX-N-29556	LZ	03/09/18	chr	Li-Qing Lei	03/09/21	61729		A3
Y	ELX-N-32780	YY	02/26/19	appd	Tim.Yao	03/09/21	type Product Customer Drawing		
sheet index	revision sheet								





P.C. BOARD LAYOUT
STYLE 1 APPLY FOR TYPE 1 & 2




P.C. BOARD LAYOUT
STYLE 2 APPLY FOR TYPE 3

NOTES:

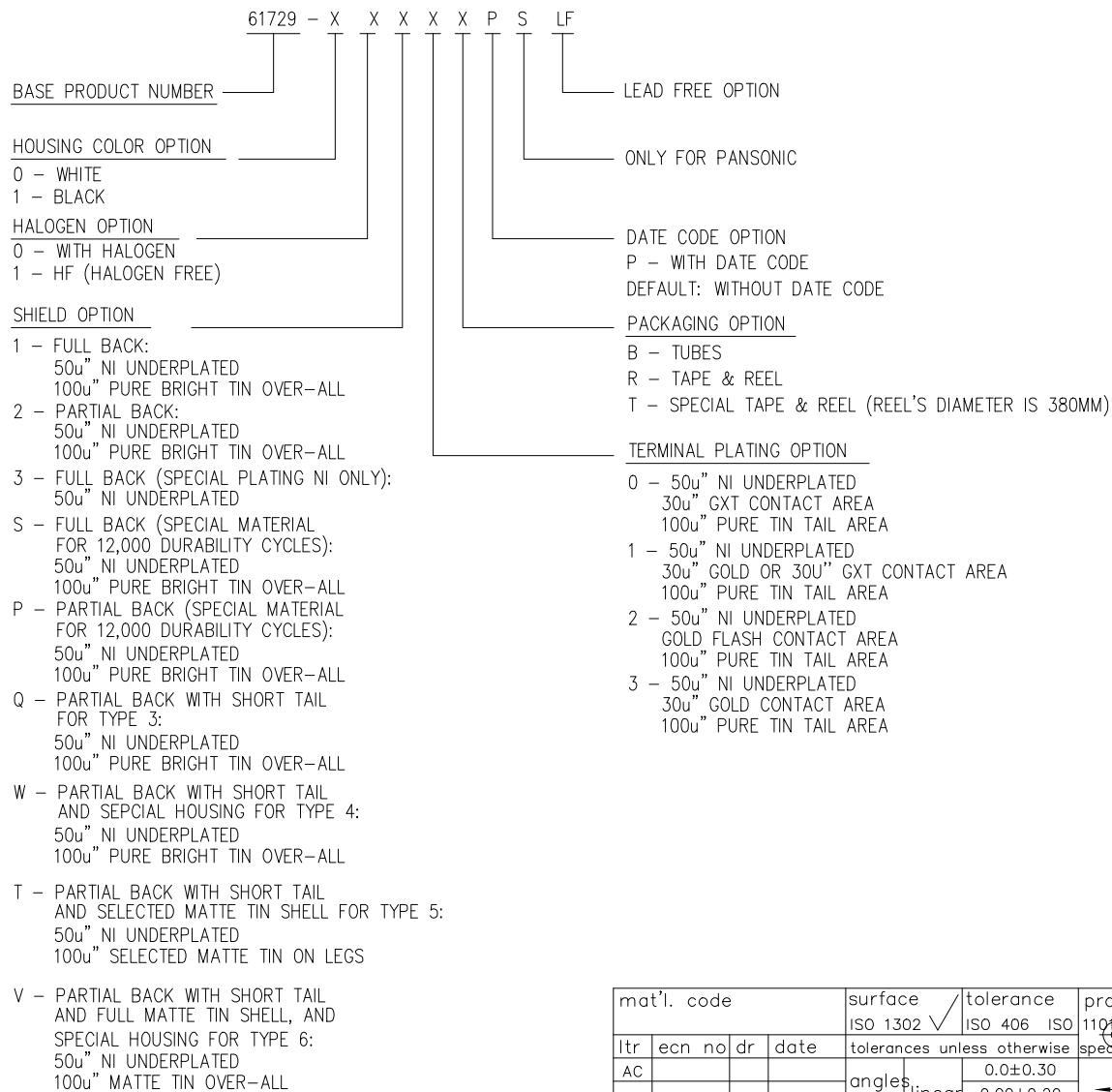
1. MATERIAL:
SHIELD & CONTACTS: COPPER ALLOY
HOUSING: UL 94V-0 ,HIGH TEMPERATURE THERMOPLASTIC.
COLOR: SEE PRODUCT NUMBER CODE.
2. PLATING: SEE PRODUCT NUMBER CODE.
SHIELD: BRIGHT TIN, NICKEL UNDERPLATE(USED FOR WAVE SOLDER PROCESS),
PLATING NICKEL ONLY(USED FOR PIP PROCESS).
3. DATUMS & BASIC DIMENSIONS TO BE DETERMINED BY CUSTOMER
4. RECOMMENDED BOARD THICKNESS IS 1.57 mm (.062)
5. PACKING STANDARD GS-14-920 WILL BE APPLIED FOR LEAD FREE P/N'S
6. FOR LEAD FREE P/N, THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008
7. FOR LEAD FREE P/N'S, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFRO-RED OR VAPOR PHASE REFLOW OVEN.
8. THE PART CAN BE USED FOR PIP PROCESS.

Amphenol FCI

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mat'l. code		surface ISO 1302 ✓	tolerance ISO 406 ISO 1101	projection 1101	product family HPL 511 USB2.0
ltr	ecn no	dr	date	tolerances unless otherwise specified	title
AC				0.0±0.30 0.00±0.20 0.000±0.10	USB RECEPTACLE B TYPE
				linear 0°±2'	mm scale 1:1
		dr	Yuan-Yuan Bao	03/09/21	
		eng	Yuan-Yuan Bao	03/09/21	
		chr	Li-Qing Lei	03/09/21	
		appd	Tim Yao	03/09/21	
sheet index	revision sheet				dwg no 61729 sheet 2 of 3 size A3 type Product Customer Drawing

PRODUCT NUMBER CODE:



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mat'l. code		surface	tolerance	projection	product family
		ISO 1302 ✓	ISO 406 ISO 1101		HPL 511 USB2.0
ltr	ecn no	dr	date	tolerances unless otherwise specified	title
AC				0.0±0.30 0.00±0.20 0.000±0.10	USB RECEPTACLE B TYPE
				angles linear 0°±2'	mm
				dr Yuan-Yuan Bao 03/09/21	scale 1:1
				eng Yuan-Yuan Bao 03/09/21	Amphenol FCI
				chr Li-Qing Lei 03/09/21	dwg no 61729 sheet 3 of 3 size A3
				appd Tim.Yao 03/09/21	type Product Customer Drawing
sheet index	revision sheet				